Electronic Patent Application Fee Transmittal							
Application Number:	105	10519741					
Filing Date:	04-	04-Nov-2005					
Title of Invention:	Me ser	Method for contacting parts of a component integrated into a semiconductor substrate					
First Named Inventor/Applicant Name:	Luc	Ludwig Dittmar					
Filer:	Jar	James Kesterson/Jackie Grant					
Attorney Docket Number:	200	2002 P 09188 US					
Filed as Large Entity							
U.S. National Stage under 35 USC 371 Fi	ling	Fees					
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)				
Miscellaneous:								
Request for continued examination	1801	1	810	810				
	Total in USD (\$)			810				